

Microstrip Cross-coupled Interdigital SIR Based Bandpass Filter

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Abstract. A simple and compact 4.9 GHz bandpass filter for C-band applications is proposed. This paper presents a novel microstrip cross-coupled interdigital half-wavelength stepped impedance resonator (SIR) based bandpass filter (BPF). The designed structure is similar to that of a combination of two parallel interdigital capacitors. The scattering parameters of the structure are measured using vector network analyzer (VNA). The self-generated capacitive and inductive reactances within the interdigital resonators exhibited in a resonance frequency of 4.9 GHz. The resonant frequency and bandwidth of the capacitive cross-coupled resonator is directly optimized from the physical arrangement of the resonators. The measured insertion loss (S_{21}) and return loss (S_{11}) were 0.3 dB and 28 dB, respectively, at resonance frequency which were almost close to the simulation results.

Keywords

Bandpass filter, interdigital resonator, stepped impedance resonator (SIR), half wavelength SIR resonator.

1. Introduction

Bandpass filters are essential devices, commonly found in both receivers and transmitters in the various fields of communication systems, such as mobile phones, terrestrial networks, satellite communications, and many other contemporary applications [1]. However, the technical limitations of the lump elements RLC, such as precise value problem, mounting problem, costly less tolerance components, discrete components occupy larger space, discrete inductor itself bulky, difficult to manage in RF circuitry, lump components consume larger power, and susceptibility to parasitic effects in the gigahertz range. In fact, the discrete components consume much current because a resistor, R dissipates power as an ohmic loss (I^2R) and also converts into heat energy which is also proportional to the size of component itself. Similarly the bulky discrete inductors naturally leak unnecessary more magnetic flux while converting electric current into magnetic field and larger size capacitors also lose some more electric field as the electric current passes through them. The qual-

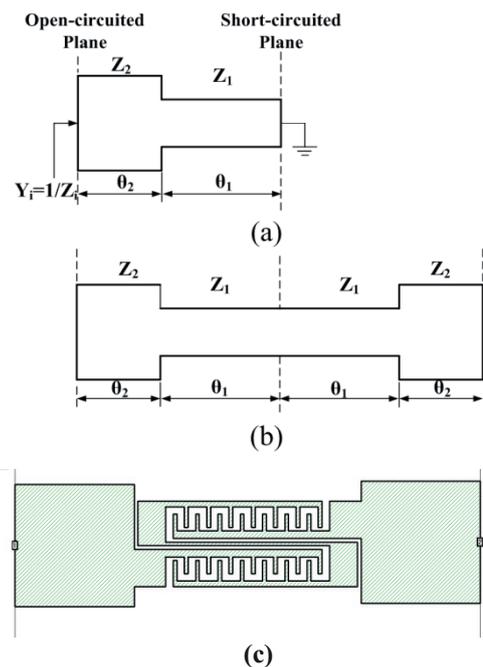


Fig. 1. The basic structures of SIR resonators: (a) Quarter-wavelength type. (b) Half-wavelength type. (c) Proposed $\lambda/2$ structure of CISIR.

ity of bandpass filters is extremely important. Thus, small size and high performance filters are needed to reduce the cost and improve the system performance. They can be designed in many different ways. Planar filters provide good miniaturization ability. The planar filters have been fabricated using printed circuit technology and are suitable for commercial applications due to their small size and lower fabrication cost [2]-[4]. A conventional half-wavelength open line microstrip resonator is too large to be used in the modern communication system such as 900 MHz, 1800 MHz for personal communication systems (PCS). The compact high performance microwave bandpass filters are highly desirable in the modern wireless communications systems. The designed hairpin filters [5]-[8] were folded from the open line $\lambda/2$ wavelength microstrip resonator to become U-shaped resonators make progress in circuit size reduction from the parallel-coupled line structure. Since 1989, practically the miniaturized hairpin resonator was developed by several researchers, [9]-[12]. Since microstrip resonators are the basic components of a planar

interdigital capacitor can be expressed as a series combination of resistor R , inductor L , and capacitor C (RLC model).

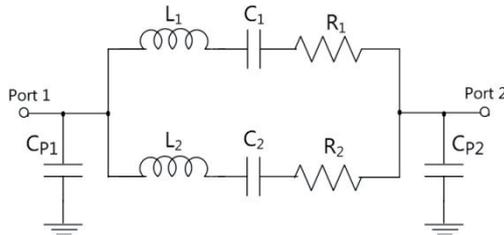


Fig. 3. Equivalent circuit of the CISIR bandpass filter.

From the physical structure of CISIR design layout, the interdigital capacitance value comparatively dominates the existing values of L and R , so that the structure is intentionally called as cross-coupled interdigital stepped-impedance resonator (CISIR) type. An equivalent inductive effect in the first interdigital capacitance (C_1) is modeled as L_1 and small value of equivalent resistance in series with those components is represented by R_1 . Similarly, equivalent circuit components L_2 and R_2 belong to the second parallel branch of interdigital capacitance (C_2). We also assume an effect of the port pad (metal surface) through dielectric material-to-substrate metal (ground) capacitances which are considered as pad capacitances, C_{p1} and C_{p2} for the port 1 and port 2, respectively. The major circuit part of the planar CISIR equivalent circuit is between those pad capacitances. The self-resonant frequency is generated when two parallel interdigital resonators are electro-magnetically coupled each other in proper way. Hence, Fig. 3 demonstrates the parallel connection of two interdigital capacitors with symmetrical port 1 and port 2. The CISIR filter is designed by splitting the basic SIR structure. By splitting the SIR structure using the cross-coupled interdigital techniques, the overall CISIR length (L_1) becomes 25 mm. That means it saved 5 mm compared with standard half-wavelength SIR structure. It is the main concept applied to the proposed BPF design to get a desired resonance frequency and the bandwidth using splitting SIR structure.

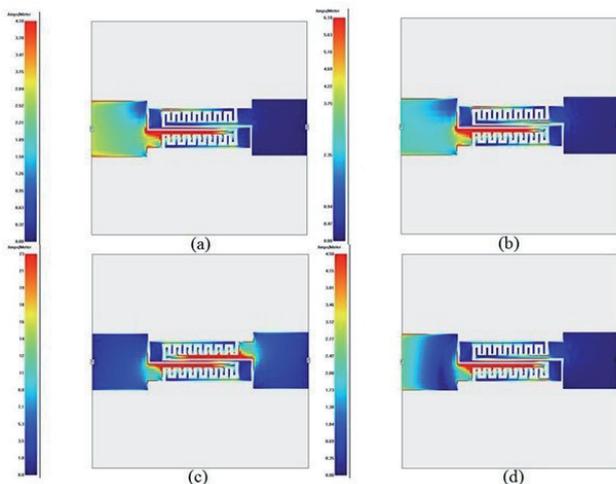


Fig. 4. The current distributions in the CISIR bandpass filter at (a) 3.5 GHz, (b) 4.0 GHz, (c) 5.0 GHz, (d) 6.0 GHz.

The current distributions of the proposed resonator at the different operating frequencies are illustrated in Fig. 4. The current distributions at randomly (a) 3.5 GHz, (b) 4.0 GHz, (c) 5.0 GHz and (d) 6.0 GHz were investigated using the Sonnet EM simulator. It also shows the current density conditions of the designed resonator at the significant states around the resonance conditions. Fig. 4(c) shows the essential state of equal and well current distribution at the 5.0 GHz resonant frequency compared to the other adjacent frequencies. The current distributions in the various operating frequencies were presented by the help of EM simulation while taking place in the design steps. At series resonance, the current distribution should be equal at resonance state, because the reactive components cancel each other and leave only the resistance, resulting in the maximum current flowing in that condition rather than those found in the other frequency bands. Fig. 5 shows the simulated S-parameter responses of insertion loss (S_{21}) of 0.25 dB and return loss (S_{11}) of 38 dB. It also shows the simulated resonance frequency of 5.0 GHz and 3dB pass-band bandwidth of 400 MHz. The CISIR bandpass filter design; analysis and simulation were accomplished with the help of commercially available computer aided design SONNET electromagnetic tool.

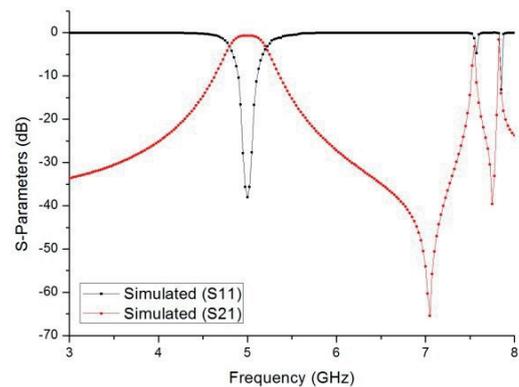


Fig. 5. Simulated S-Parameter responses of the CISIR.

4. Fabrication and Measurements

The proposed CISIR bandpass filter was fabricated on a Teflon substrate with the dielectric constant, ϵ_r of 2.52 and a thickness of 0.54 mm. The photograph of the fabricated CISIR bandpass filter is shown in Fig. 6. The proposed microstrip bandpass filter was fabricated with photolithographic and wet etching techniques. The overall physical size of the filter is of $(6.6 \times 25) \text{ mm}^2$. The designed CISIR bandpass filter has the following dimensions: $L_1 = 25 \text{ mm}$, $L_2 = 6.4 \text{ mm}$, $L_3 = 9.9 \text{ mm}$, $L_4 = 1.7 \text{ mm}$, $W_1 = 6.6 \text{ mm}$, $W_2 = 2.0 \text{ mm}$, $W_3 = 3.5 \text{ mm}$, $W_4 = 1.6 \text{ mm}$, $W_5 = 1.1 \text{ mm}$, $S_1 = 1.0 \text{ mm}$, $S_2 = 0.4 \text{ mm}$, $S_3 = 0.4 \text{ mm}$, $S_4 = 0.2 \text{ mm}$, $d_1 = 0.2 \text{ mm}$, $d_2 = 0.9 \text{ mm}$, $d_3 = 0.2 \text{ mm}$, $d_4 = 1.1 \text{ mm}$, $d_5 = 0.4 \text{ mm}$, $g_1 = 0.2 \text{ mm}$, and $g_2 = 0.4 \text{ mm}$. The CISIR is resonated at a 4.9 GHz center frequency with around 400 MHz effective bandwidth. The usable bandwidth of the CISIR bandpass filter is measured in 3 dB passband range. Furthermore, the coupling gaps g_1 and g_2

are narrow and thus remarkably more sensitive to fabrication unavoidable deviations than the other parameters [16]. The observed differences between the simulations and measurements can be attributed to the fabrication tolerances. The conductor loss, coupling loss, the dielectric loss and the non-ideal microstrip coaxial line transitions are thought to contribute to the higher insertion loss seen in the physical measurements compared to the simulation.

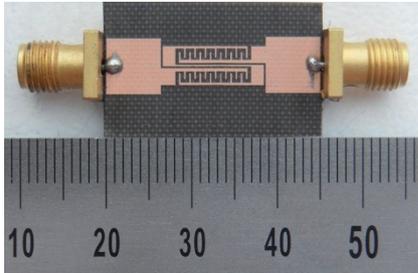


Fig. 6. Photograph of the fabricated CISIR bandpass filter.

The fabricated CISIR filter was measured using Agilent 8510C vector network analyzer (VNA). The measured insertion loss (S_{21}) and return loss (S_{11}) were 0.3 dB and 28 dB at the center frequency of 4.9 GHz. At the 4.9 GHz center frequency, this design was shown to have 3 dB passband; 400 MHz effective bandwidth was measured. Fig. 7 shows the S-parameter response comparison to both simulated and measured results. The graphical representation in Fig. 7 shows that the measured resonant frequency, f_0 of the CISIR filter was slightly drifted 100 MHz ahead from the simulated f_0 of 5.0 GHz. The cause of resonance around 7.8 GHz is the result of spurious resonances. In fact, the fundamental resonance and the spurious resonances can be determined by choosing the proper impedance ratio. In some cases, it may be slightly affected by the harmonic products and the effect of parasitic capacitances. The single mode simulated passband response was also changed to dual-mode response while measured in the experiment.

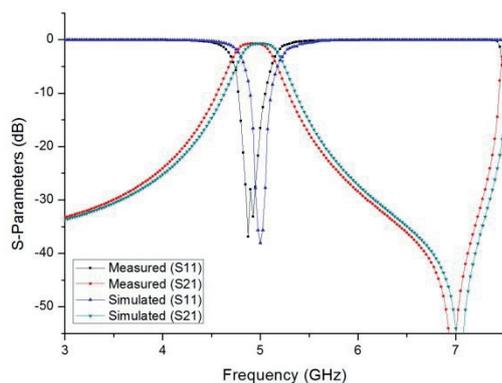


Fig. 7. Simulated and measured S-Parameter responses of the CISIR.

The simulated resonance frequency was set in single mode characteristic as depicted in Fig. 5, while the measured S-parameter responses were little bit shifted ahead about 0.1 GHz with dual-mode characteristic as shown in Fig. 7. The non-uniform dual-mode was recorded while

measurement taken, its main causes can be due to minor misalignment of the RF coaxial connectors' orientation in the ports, soldering joints, and some electrostatic as well as parasitic capacitances effects during the measurement.

5. Conclusion

The proposed novel CISIR bandpass filter was fabricated on a Teflon substrate with the dielectric constant, ϵ_r of 2.52 and a thickness of 0.54 mm and characterized. It is designed that based on in the form of cross-coupled two interdigital resonators. The measured results of the BPF well agreed with simulation results since the return loss in the both simulation and measurement results shown below the 28 dB at the center operating frequency of 4.9 GHz. This is due to use of cross-coupled by splitting the basic SIR structure that results more coupling effect; the CISIR structure can be reduced more in size using monolithic microwave integrated circuit (MMIC) technology. The CISIR can be extensively used in low-power to medium-power C-band RF transceiver systems.

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References

- [1] POZAR, D. M. *Microwave Engineering*. 3rd edition. New York, 2004.
- [2] MANDAL, M. K., SANYAL, S. Compact wideband bandpass filter using microstrip to slotline broadside-coupling. *IEEE Microwave and Wireless Components Letters*, 2007, vol. 17, p. 640-642.
- [3] CHEN, F., TU, Z., CHU, Q., YANG, J. A novel microstrip open-loop resonator filter for high selectivity application. In *Proceedings of Asia-Pacific Microwave Conference 2007*. 11-14 December 2007.
- [4] TU, W. H., CHANG, K. Compact microstrip filter using open stub and spurline. *IEEE Microwave and Wireless Components Letters*, 2005, vol. 15, p. 268-270.
- [5] VAGNER, P., KASAL, M. A novel bandpass filter using a combination of open-loop defected ground structure and half-wavelength microstrip resonators. *Radioengineering*, 2010, vol. 19, no. 3, p. 392-396.
- [6] JUNG, D. J., LEE, J. K., CHANG, K. Wideband bandpass filter using microstrip ring. *Microwave and Optical Technology Letters*, 2011, vol. 53, p. 154-155.
- [7] LEE, G. A. MEGAHED, M. A., FLAVIIS, F. D. Low-cost compact spiral inductor resonator filters for system-in-a-package. *IEEE Transactions on Advanced Packaging*, 2005, vol. 28, p. 761-771.
- [8] BAO, Z. H., CHEN, J. X., TANG, H., ZHOU, L. H. Compact dual-band bandpass filter using slot-line resonator. *Microwave and Optical Technology Letters*, 2010, vol. 52, p. 2299-2300.

- [9] SAGAWA, M., TAKAHASHI, K., MAKIMOTO, M. Miniaturized hairpin resonator filters and their application to receiver front-end MIC's. *IEEE Trans. Microwave Theory Tech.*, 1989, vol. 37, p. 1991-1997.
- [10] MATTHAEI, G. L., FENZI, N. O., FORSE, R. J., ROHLFING, S. M. Hairpin-comb filters for HTS and other narrow-band applications. *IEEE Trans. Microwave Theory Tech.*, 1997, vol. 45, p. 1226-1231.
- [11] YABUKI, H., SAGAWA, M., MAKIMOTO, M. Voltage controlled push-push oscillators using miniaturized hairpin resonators. *IEEE MTT-S Int Microwave Symp Dig.*, 1991, vol. 3, p. 1175-1178.
- [12] LEE, S. Y., TSAI, C. M. New cross-coupled filter design using improved hairpin resonators. *IEEE Trans. Microwave Theory Tech.*, 2000, vol. 48, p. 2482-2490.
- [13] SHRESTHA, B., MAHARJAN, R. K., CHO, S., YOON, K. C., KIM, N. Y. A low-phase noise oscillator using spurline resonator for I-band application. In *Asia-Pacific Microwave Conference, APMC-2010*. Yokohama (Japan), 2010, p. 469-472.
- [14] HONG, J. S., LANCASTER, M. J. *Microstrip Filters for RF/Microwave Applications*. A Wiley-Interscience Publication, John Wiley & Sons, Inc. 2001.
- [15] MAKIMOTO, M., YAMASHITA, S. *Microwave Resonators and Filters for Wireless Communications, Theory, Design and Application*. Berlin Heidelberg New York: Springer-Verlag, 2001.
- [16] WADELL, B. C. *Transmission Line Design Handbook*. USA: Artech House, 1991.

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